

To: I. B. Patel Fax 703 746-3448 Total of 4 pages

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INFORMAL AMENDMENT

IN THE UNITED STATES PATENT AND
TRADEMARK OFFICE

Minneapolis, Minnesota
April 21, 2003

Applicant: Spielberg, et al.

Group: 2827

Serial No.: 09/998,348

Examiner: Patel

Filed: November 30, 2001

Atty. Docket No.: H0002128-US

For: BALL GRID ARRAY PACKAGE

AMENDMENT

Honorable Commissioner for Patents
Box Non-Fee Amendment
Washington, D.C. 20231

Dear Sir or Madam:

Responsive to the Official Communication having a mailing date of December 18, 2002,
please amend the above application as follows relative to the amendment filed on March 18, 2003:

Amendments to the Claims

Claim 1 (currently amended). A ball grid array mounted circuit comprising;;

a flexible stress relief substrate having a top surface and a bottom surface;

spaced conductive vias extending between the top surface and said bottom surface;

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